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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	8MHz
Connectivity	I²C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	50
Program Memory Size	16KB (8K x 16)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	678 x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	External
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	68-LCC (J-Lead)
Supplier Device Package	68-PLCC (24.23x24.23)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic17lc752t-08-l

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5.1.4 TIME-OUT SEQUENCE

On power-up, the time-out sequence is as follows: First, the internal POR signal goes high when the POR trip point is reached. If MCLR is high, then both the OST and PWRT timers start. In general, the PWRT time-out is longer, except with low frequency crystals/resonators. The total time-out also varies based on oscillator configuration. Table 5-1 shows the times that are associated with the oscillator configuration. Figure 5-5 and Figure 5-6 display these time-out sequences.

If the device voltage is not within electrical specification at the end of a time-out, the MCLR/VPP pin must be held low until the voltage is within the device specification. The use of an external RC delay is sufficient for many of these applications.

The time-out sequence begins from the first rising edge of MCLR.

Table 5-3 shows the RESET conditions for some special registers, while Table 5-4 shows the initialization conditions for all the registers.

TABLE 5-1: TIME-OUT IN VARIOUS SITUATIONS

Oscillator Configuration	POR, BOR	Wake-up from SLEEP	MCLR Reset
XT, LF	Greater of: 96 ms or 1024TOSC	1024TOSC	—
EC, RC	Greater of: 96 ms or 1024TOSC	—	—

TABLE 5-2: STATUS BITS AND THEIR SIGNIFICANCE

POR	BOR(1)	TO	PD	Event
0	0	1	1	Power-on Reset
1	1	1	0	MCLR Reset during SLEEP or interrupt wake-up from SLEEP
1	1	0	1	WDT Reset during normal operation
1	1	0	0	WDT Wake-up during SLEEP
1	1	1	1	MCLR Reset during normal operation
1	0	1	1	Brown-out Reset
0	0	0	x	Illegal, TO is set on POR
0	0	x	0	Illegal, PD is set on POR
x	x	1	1	CLRWDT instruction executed

Note 1: When BODEN is enabled, else the BOR status bit is unknown.

TABLE 5-3: RESET CONDITION FOR THE PROGRAM COUNTER AND THE CPUSTA REGISTER

Event		PCH:PCL	CPUSTA(4)	OST Active
Power-on Reset		0000h	--11 1100	Yes
Brown-out Reset		0000h	--11 1110	Yes
MCLR Reset during normal operation		0000h	--11 1111	No
MCLR Reset during SLEEP		0000h	--11 1011	Yes(2)
WDT Reset during normal operation		0000h	--11 0111	No
WDT Reset during SLEEP(3)		0000h	--11 0011	Yes(2)
Interrupt Wake-up from SLEEP	GLINTD is set	PC + 1	--11 1011	Yes(2)
	GLINTD is clear	PC + 1(1)	--10 1011	Yes(2)

Legend: u = unchanged, x = unknown, - = unimplemented, read as '0'

Note 1: On wake-up, this instruction is executed. The instruction at the appropriate interrupt vector is fetched and then executed.

2: The OST is only active (on wake-up) when the oscillator is configured for XT or LF modes.

3: The Program Counter = 0; that is, the device branches to the RESET vector and places SFRs in WDT Reset states. This is different from the mid-range devices.

4: When BODEN is enabled, else the BOR status bit is unknown.

EXAMPLE 6-2: SAVING STATUS AND WREG IN RAM (NESTED)

```
; The addresses that are used to store the CPUSTA and WREG values must be in the data memory
; address range of 1Ah - 1Fh. Up to 6 locations can be saved and restored using the MOVFP
; instruction. This instruction neither affects the status bits, nor corrupts the WREG register.
; This routine uses the FRS0, so it controls the FS1 and FS0 bits in the ALUSTA register.
;
Nobank_FSR      EQU    0x40
Bank_FSR        EQU    0x41
ALU_Temp        EQU    0x42
WREG_TEMP       EQU    0x43
BSR_S1          EQU    0x01A        ; 1st location to save BSR
BSR_S2          EQU    0x01B        ; 2nd location to save BSR (Label Not used in program)
BSR_S3          EQU    0x01C        ; 3rd location to save BSR (Label Not used in program)
BSR_S4          EQU    0x01D        ; 4th location to save BSR (Label Not used in program)
BSR_S5          EQU    0x01E        ; 5th location to save BSR (Label Not used in program)
BSR_S6          EQU    0x01F        ; 6th location to save BSR (Label Not used in program)
;
INITIALIZATION                      ;
        CALL    CLEAR_RAM           ; Must Clear all Data RAM
;
INIT_POINTERS                       ; Must Initialize the pointers for POP and PUSH
        CLRF    BSR, F              ; Set All banks to 0
        CLRF    ALUSTA, F           ; FSR0 post increment
        BSF     ALUSTA, FS1
        CLRF    WREG, F             ; Clear WREG
        MOVLW   BSR_S1              ; Load FSR0 with 1st address to save BSR
        MOVWF   FSR0
        MOVWF   Nobank_FSR
        MOVLW   0x20
        MOVWF   Bank_FSR
        :
        :                           ; Your code
        :
        :                           ; At Interrupt Vector Address
PUSH    BSF     ALUSTA, FS0         ; FSR0 has auto-increment, does not affect status bits
        BCF     ALUSTA, FS1         ; does not affect status bits
        MOVFP   BSR, INDF0          ; No Status bits are affected
        CLRF    BSR, F              ; Peripheral and Data RAM Bank 0 No Status bits are affected
        MOVPF   ALUSTA, ALU_Temp    ;
        MOVPF   FSR0, Nobank_FSR    ; Save the FSR for BSR values
        MOVPF   WREG, WREG_TEMP     ;
        MOVFP   Bank_FSR, FSR0      ; Restore FSR value for other values
        MOVFP   ALU_Temp, INDF0     ; Push ALUSTA value
        MOVFP   WREG_TEMP, INDF0    ; Push WREG value
        MOVFP   PCLATH, INDF0       ; Push PCLATH value
        MOVPF   FSR0, Bank_FSR      ; Restore FSR value for other values
        MOVFP   Nobank_FSR, FSR0    ;
        ;
        :                           ; Interrupt Service Routine (ISR) code
        ;
POP     CLRF    ALUSTA, F           ; FSR0 has auto-decrement, does not affect status bits
        MOVFP   Bank_FSR, FSR0      ; Restore FSR value for other values
        DECF    FSR0, F             ;
        MOVFP   INDF0, PCLATH       ; Pop PCLATH value
        MOVFP   INDF0, WREG         ; Pop WREG value
        BSF     ALUSTA, FS1         ; FSR0 does not change
        MOVPF   INDF0, ALU_Temp     ; Pop ALUSTA value
        MOVPF   FSR0, Bank_FSR      ; Restore FSR value for other values
        DECF    Nobank_FSR, F       ;
        MOVFP   Nobank_FSR, FSR0    ; Save the FSR for BSR values
        MOVFP   ALU_Temp, ALUSTA    ;
        MOVFP   INDF0, BSR          ; No Status bits are affected
;
        RETFIE                      ; Return from interrupt (enable interrupts)
```

TABLE 7-3: SPECIAL FUNCTION REGISTERS (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	$\overline{\text{MCLR}}$, WDT
Bank 6											
10h	SSPADD	SSP Address Register in I^2C Slave mode. SSP Baud Rate Reload Register in I^2C Master mode								0000 0000	0000 0000
11h	SSPCON1	WCOL	SSPOV	SSPEN	CKP	SSPM3	SSPM2	SSPM1	SSPM0	0000 0000	0000 0000
12h	SSPCON2	GCEN	AKSTAT	AKDT	AKEN	RCEN	PEN	RSEN	SEN	0000 0000	0000 0000
13h	SSPSTAT	SMP	CKE	D/$\overline{\text{A}}$	P	S	R/$\overline{\text{W}}$	UA	BF	0000 0000	0000 0000
14h	SSPBUF	Synchronous Serial Port Receive Buffer/Transmit Register								xxxx xxxx	uuuu uuuu
15h	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
16h	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
17h	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
Bank 7											
10h	PW3DCL	DC1	DC0	TM2PW3	—	—	—	—	—	xx0- ----	uu0- ----
11h	PW3DCH	DC9	DC8	DC7	DC6	DC5	DC4	DC3	DC2	xxxx xxxx	uuuu uuuu
12h	CA3L	Capture3 Low Byte								xxxx xxxx	uuuu uuuu
13h	CA3H	Capture3 High Byte								xxxx xxxx	uuuu uuuu
14h	CA4L	Capture4 Low Byte								xxxx xxxx	uuuu uuuu
15h	CA4H	Capture4 High Byte								xxxx xxxx	uuuu uuuu
16h	TCON3	—	CA4OVF	CA3OVF	CA4ED1	CA4ED0	CA3ED1	CA3ED0	PWM3ON	-000 0000	-000 0000
17h	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
Bank 8(3)											
10h(3)	DDRH	Data Direction Register for PORTH								1111 1111	1111 1111
11h(3)	PORTH(4)	RH7/ AN15	RH6/ AN14	RH5/ AN13	RH4/ AN12	RH3	RH2	RH1	RH0	xxxx xxxx	uuuu uuuu
12h(3)	DDRJ	Data Direction Register for PORTJ								1111 1111	1111 1111
13h(3)	PORTJ(4)	RJ7	RJ6	RJ5	RJ4	RJ3	RJ2	RJ1	RJ0	xxxx xxxx	uuuu uuuu
14h(3)	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
15h(3)	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
16h(3)	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
17h(3)	Unimplemented	—	—	—	—	—	—	—	—	---- ----	---- ----
Unbanked											
18h	PRODL	Low Byte of 16-bit Product (8 x 8 Hardware Multiply)								xxxx xxxx	uuuu uuuu
19h	PRODH	High Byte of 16-bit Product (8 x 8 Hardware Multiply)								xxxx xxxx	uuuu uuuu

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0', q = value depends on condition.
Shaded cells are unimplemented, read as '0'.

Note 1: The upper byte of the program counter is not directly accessible. PCLATH is a holding register for PC<15:8> whose contents are updated from, or transferred to, the upper byte of the program counter.

2: The $\overline{\text{TO}}$ and $\overline{\text{PD}}$ status bits in CPUSTA are not affected by a $\overline{\text{MCLR}}$ Reset.

3: Bank 8 and associated registers are only implemented on the PIC17C76X devices.

4: This is the value that will be in the port output latch.

5: When the device is configured for Microprocessor or Extended Microcontroller mode, the operation of this port does not rely on these registers.

6: On any device RESET, these pins are configured as inputs.

8.2 Table Writes to External Memory

Table writes to external memory are always two-cycle instructions. The second cycle writes the data to the external memory location. The sequence of events for an external memory write are the same for an internal write.

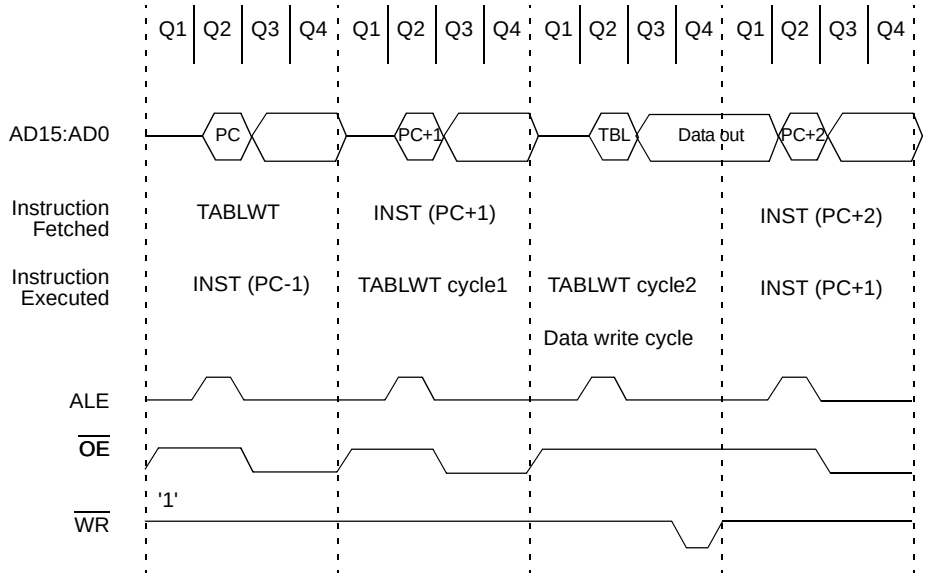
8.2.1 TABLE WRITE CODE

The "i" operand of the TABLWT instruction can specify that the value in the 16-bit TBLPTR register is automatically incremented (for the next write). In Example 8-1, the TBLPTR register is not automatically incremented.

EXAMPLE 8-1: TABLE WRITE

```
CLRWDT                  ; Clear WDT
MOVLW   HIGH (TBL_ADDR) ; Load the Table
MOVWF   TBLPTRH         ;   address
MOVLW   LOW (TBL_ADDR)  ;
MOVWF   TBLPTRL         ;
MOVLW   HIGH (DATA)     ; Load HI byte
TLWT    1, WREG         ;   in TABLATH
MOVLW   LOW (DATA)      ; Load LO byte
TABLWT  0,0,WREG        ;   in TABLATL
                        ;   and write to
                        ;   program memory
                        ;   (Ext. SRAM)
```

FIGURE 8-5: TABLWT WRITE TIMING (EXTERNAL MEMORY)



Note: If external write and GLINTD = '1' and Enable bit = '1', then when '1' → Flag bit, do table write. The highest pending interrupt is cleared.

TABLE 10-11: PORTF FUNCTIONS

Name	Bit	Buffer Type	Function
RF0/AN4	bit0	ST	Input/output or analog input 4.
RF1/AN5	bit1	ST	Input/output or analog input 5.
RF2/AN6	bit2	ST	Input/output or analog input 6.
RF3/AN7	bit3	ST	Input/output or analog input 7.
RF4/AN8	bit4	ST	Input/output or analog input 8.
RF5/AN9	bit5	ST	Input/output or analog input 9.
RF6/AN10	bit6	ST	Input/output or analog input 10.
RF7/AN11	bit7	ST	Input/output or analog input 11.

Legend: ST = Schmitt Trigger input

TABLE 10-12: REGISTERS/BITS ASSOCIATED WITH PORTF

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on POR, BOR	$\overline{\text{MCLR}}$, WDT
10h, Bank 5	DDRF	Data Direction Register for PORTF								1111 1111	1111 1111
11h, Bank 5	PORTF	RF7/ AN11	RF6/ AN10	RF5/ AN9	RF4/ AN8	RF3/ AN7	RF2/ AN6	RF1/ AN5	RF0/ AN4	0000 0000	0000 0000
15h, Bank 5	ADCON1	ADCS1	ADCS0	ADFM	—	PCFG3	PCFG2	PCFG1	PCFG0	000- 0000	000- 0000

Legend: x = unknown, u = unchanged, - = unimplemented, read as '0'. Shaded cells are not used by PORTF.

15.2.1.1 Addressing

Once the MSSP module has been enabled, it waits for a START condition to occur. Following the START condition, the 8-bits are shifted into the SSPSR register. All incoming bits are sampled with the rising edge of the clock (SCL) line. The value of register SSPSR<7:1> is compared to the value of the SSPADD register. The address is compared on the falling edge of the eighth clock (SCL) pulse. If the addresses match and the BF and SSPOV bits are clear, the following events occur:

a) The SSPSR register value is loaded into the SSPBUF register on the falling edge of the 8th SCL pulse.
b) The buffer full bit, BF, is set on the falling edge of the 8th SCL pulse.
c) An $\overline{ACK}$ pulse is generated.
d) SSP interrupt flag bit, SSPIF (PIR2<7>), is set (interrupt is generated if enabled) - on the falling edge of the 9th SCL pulse.

In 10-bit address mode, two address bytes need to be received by the slave. The five Most Significant bits (MSbs) of the first address byte specify if this is a 10-bit address. Bit R/$\overline{W}$ (SSPSTAT<2>) must specify a write so the slave device will receive the second address byte. For a 10-bit address, the first byte would equal '1111 0 A9 A8 0', where A9 and A8 are the two MSbs of the address. The sequence of events for a 10-bit address is as follows, with steps 7- 9 for slave-transmitter:

1. Receive first (high) byte of Address (bits SSPIF, BF and bit UA (SSPSTAT<1>) are set).
2. Update the SSPADD register with second (low) byte of Address (clears bit UA and releases the SCL line).
3. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
4. Receive second (low) byte of Address (bits SSPIF, BF and UA are set).
5. Update the SSPADD register with the first (high) byte of Address. This will clear bit UA and release the SCL line.
6. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.
7. Receive Repeated Start condition.
8. Receive first (high) byte of Address (bits SSPIF and BF are set).
9. Read the SSPBUF register (clears bit BF) and clear flag bit SSPIF.

Note:	Following the Repeated Start condition (step 7) in 10-bit mode, the user only needs to match the first 7-bit address. The user does not update the SSPADD for the second half of the address.

15.2.1.2 Slave Reception

When the R/$\overline{W}$ bit of the address byte is clear and an address match occurs, the R/$\overline{W}$ bit of the SSPSTAT register is cleared. The received address is loaded into the SSPBUF register.

When the address byte overflow condition exists, then no acknowledge ($\overline{ACK}$) pulse is given. An overflow condition is defined as either bit BF (SSPSTAT<0>) is set, or bit SSPOV (SSPCON1<6>) is set.

An SSP interrupt is generated for each data transfer byte. Flag bit SSPIF (PIR2<7>) must be cleared in software. The SSPSTAT register is used to determine the status of the received byte.

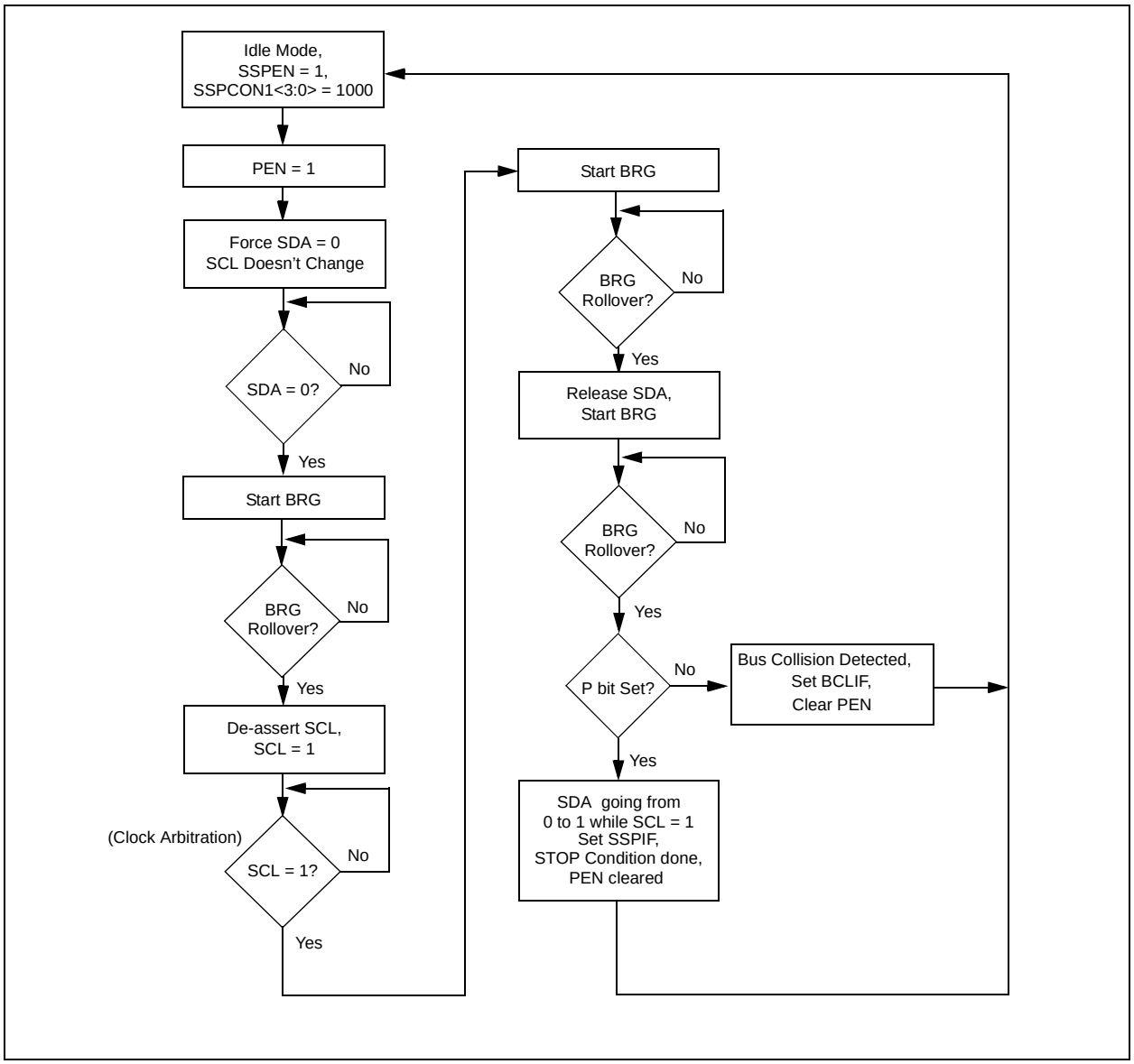
Note:	The SSPBUF will be loaded if the SSPOV bit is set and the BF flag is cleared. If a read of the SSPBUF was performed, but the user did not clear the state of the SSPOV bit before the next receive occurred, the $\overline{ACK}$ is not sent and the SSPBUF is updated.

TABLE 15-2: DATA TRANSFER RECEIVED BYTE ACTIONS

Status Bits as Data Transfer is Received		SSPSR → SSPBUF	Generate $\overline{ACK}$ Pulse	Set bit SSPIF (SSP Interrupt occurs if enabled)
BF	SSPOV			
0	0	Yes	Yes	Yes
1	0	No	No	Yes
1	1	No	No	Yes
0	1	Yes	No	Yes

Note 1: Shaded cells show the conditions where the user software did not properly clear the overflow condition.

FIGURE 15-32: STOP CONDITION FLOW CHART



16.4.1 A/D RESULT REGISTERS

The ADRESH:ADRESL register pair is the location where the 10-bit A/D result is loaded at the completion of the A/D conversion. This register pair is 16-bits wide. The A/D module gives the flexibility to left or right justify the 10-bit result in the 16-bit result register. The A/D Format Select bit (ADFM) controls this justification. Figure 16-6 shows the operation of the A/D result justification. The extra bits are loaded with '0's'. When an A/D result will not overwrite these locations (A/D disable), these registers may be used as two general purpose 8-bit registers.

16.5 A/D Operation During SLEEP

The A/D module can operate during SLEEP mode. This requires that the A/D clock source be set to RC (ADCS1:ADCS0 = 11). When the RC clock source is selected, the A/D module waits one instruction cycle before starting the conversion. This allows the SLEEP instruction to be executed, which eliminates all digital switching noise from the conversion. When the conversion is completed, the GO/DONE bit will be cleared, and the result loaded into the ADRES register. If the A/D interrupt is enabled, the device will wake-up from SLEEP. If the A/D interrupt is not enabled, the A/D module will then be turned off, although the ADON bit will remain set.

When the A/D clock source is another clock option (not RC), a SLEEP instruction will cause the present conversion to be aborted and the A/D module to be turned off, though the ADON bit will remain set.

Turning off the A/D places the A/D module in its lowest current consumption state.

Note:	For the A/D module to operate in SLEEP, the A/D clock source must be set to RC (ADCS1:ADCS0 = 11). To allow the conversion to occur during SLEEP, ensure the SLEEP instruction immediately follows the instruction that sets the GO/DONE bit.

16.6 Effects of a RESET

A device RESET forces all registers to their RESET state. This forces the A/D module to be turned off, and any conversion is aborted.

The value that is in the ADRESH:ADRESL registers is not modified for a Power-on Reset. The ADRESH:ADRESL registers will contain unknown data after a Power-on Reset.

FIGURE 16-6: A/D RESULT JUSTIFICATION

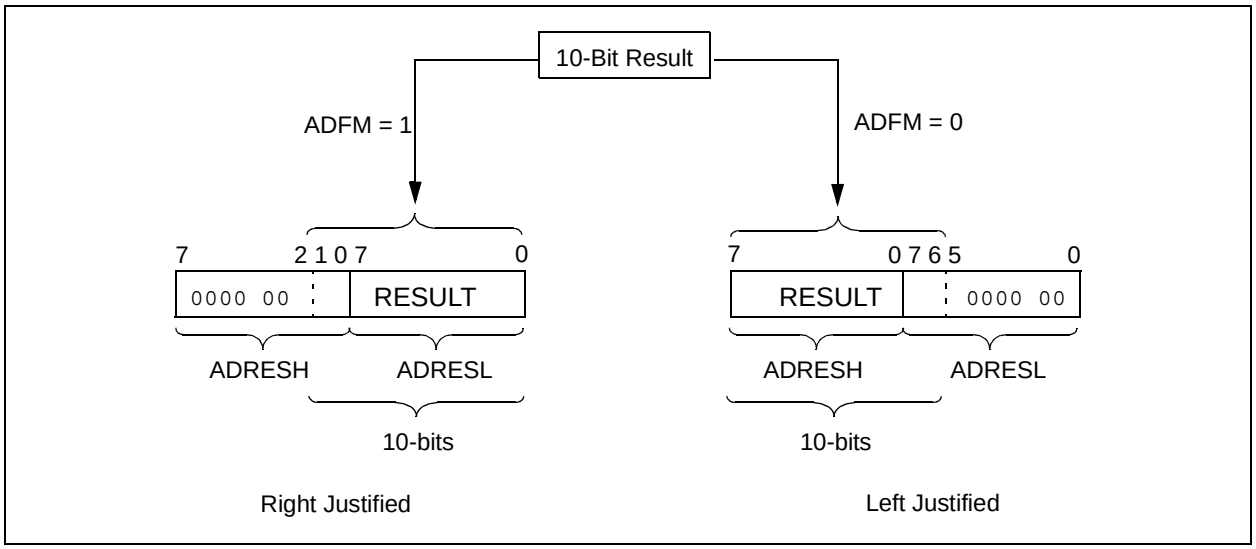


Table 18-2 lists the instructions recognized by the MPASM assembler.

Note 1:	Any unused opcode is Reserved. Use of any reserved opcode may cause unexpected operation.

All instruction examples use the following format to represent a hexadecimal number:

0xhh

where h signifies a hexadecimal digit.

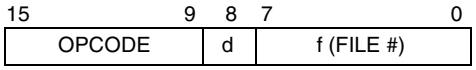
To represent a binary number:

`0000 0100b`

where b signifies a binary string.

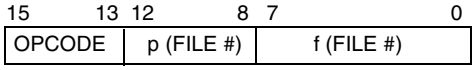
FIGURE 18-1: GENERAL FORMAT FOR INSTRUCTIONS

Byte-oriented file register operations



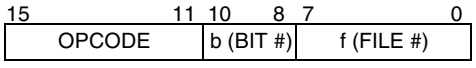
d = 0 for destination WREG
d = 1 for destination f
f = 8-bit file register address

Byte to Byte move operations



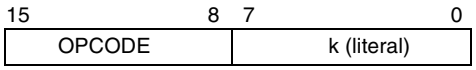
p = peripheral register file address
f = 8-bit file register address

Bit-oriented file register operations



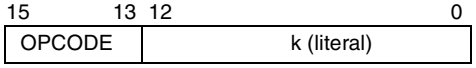
b = 3-bit address
f = 8-bit file register address

Literal and control operations



k = 8-bit immediate value

CALL and GOTO operations



k = 13-bit immediate value

18.1 Special Function Registers as Source/Destination

The PIC17C7XX's orthogonal instruction set allows read and write of all file registers, including special function registers. There are some special situations the user should be aware of:

18.1.1 ALUSTA AS DESTINATION

If an instruction writes to ALUSTA, the Z, C, DC and OV bits may be set or cleared as a result of the instruction and overwrite the original data bits written. For example, executing `CLRF ALUSTA` will clear register ALUSTA and then set the Z bit leaving `0000 0100b` in the register.

18.1.2 PCL AS SOURCE OR DESTINATION

Read, write or read-modify-write on PCL may have the following results:

Read PC:	PCH → PCLATH; PCL → dest
Write PCL:	PCLATH → PCH; 8-bit destination value → PCL
Read-Modify-Write:	PCL→ ALU operand PCLATH → PCH; 8-bit result → PCL

Where PCH = program counter high byte (not an addressable register), PCLATH = Program counter high holding latch, dest = destination, WREG or f.

18.1.3 BIT MANIPULATION

All bit manipulation instructions are done by first reading the entire register, operating on the selected bit and writing the result back (read-modify-write (R-M-W)). The user should keep this in mind when operating on some special function registers, such as ports.

Note:	Status bits that are manipulated by the device (including the interrupt flag bits) are set or cleared in the Q1 cycle. So, there is no issue on doing R-M-W instructions on registers which contain these bits

ANDWF **AND WREG with f**

Syntax: [*label*] ANDWF f,d

Operands: $0 \le f \le 255$
$d \in [0,1]$

Operation: (WREG) .AND. (f) → (dest)

Status Affected: Z

Encoding:

0000	101d	ffff	ffff

Description: The contents of WREG are AND'ed with register 'f'. If 'd' is 0 the result is stored in WREG. If 'd' is 1 the result is stored back in register 'f'.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write to destination

Example: `ANDWF REG, 1`

Before Instruction
WREG = 0x17
REG = 0xC2

After Instruction
WREG = 0x17
REG = 0x02

BCF **Bit Clear f**

Syntax: [*label*] BCF f,b

Operands: $0 \le f \le 255$
$0 \le b \le 7$

Operation: 0 → (f<b>)

Status Affected: None

Encoding:

1000	1bbb	ffff	ffff

Description: Bit 'b' in register 'f' is cleared.

Words: 1

Cycles: 1

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read register 'f'	Process Data	Write register 'f'

Example: `BCF FLAG_REG, 7`

Before Instruction
FLAG_REG = 0xC7

After Instruction
FLAG_REG = 0x47

RETFIE **Return from Interrupt**

Syntax: [*label*] RETFIE

Operands: None

Operation: TOS → (PC);
0 → GLINTD;
PCLATH is unchanged.

Status Affected: GLINTD

Encoding:

0000	0000	0000	0101

Description: Return from Interrupt. Stack is POP'ed and Top-of-Stack (TOS) is loaded in the PC. Interrupts are enabled by clearing the GLINTD bit. GLINTD is the global interrupt disable bit (CPUSTA<4>).

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	No operation	Clear GLINTD	POP PC from stack
No operation	No operation	No operation	No operation

Example: `RETFIE`

After Interrupt
PC = TOS
GLINTD = 0

RETLW **Return Literal to WREG**

Syntax: [*label*] RETLW k

Operands: $0 \le k \le 255$

Operation: k → (WREG); TOS → (PC);
PCLATH is unchanged

Status Affected: None

Encoding:

1011	0110	kkkk	kkkk

Description: WREG is loaded with the eight-bit literal 'k'. The program counter is loaded from the top of the stack (the return address). The high address latch (PCLATH) remains unchanged.

Words: 1

Cycles: 2

Q Cycle Activity:

Q1	Q2	Q3	Q4
Decode	Read literal 'k'	Process Data	POP PC from stack, Write to WREG
No operation	No operation	No operation	No operation

Example:

```
    CALL TABLE ; WREG contains table
               ;  offset value
               ;  WREG now has
               ;  table value
    :
TABLE
    ADDWF PC   ; WREG = offset
    RETLW k0   ; Begin table
    RETLW k1   ;
    :
    :
    RETLW kn   ; End of table
```

Before Instruction
WREG = 0x07

After Instruction
WREG = value of k7

19.13 PICDEM 3 Low Cost PIC16CXXX Demonstration Board

The PICDEM 3 demonstration board is a simple demonstration board that supports the PIC16C923 and PIC16C924 in the PLCC package. It will also support future 44-pin PLCC microcontrollers with an LCD Module. All the necessary hardware and software is included to run the basic demonstration programs. The user can program the sample microcontrollers provided with the PICDEM 3 demonstration board on a PRO MATE II device programmer, or a PICSTART Plus development programmer with an adapter socket, and easily test firmware. The MPLAB ICE in-circuit emulator may also be used with the PICDEM 3 demonstration board to test firmware. A prototype area has been provided to the user for adding hardware and connecting it to the microcontroller socket(s). Some of the features include a RS-232 interface, push button switches, a potentiometer for simulated analog input, a thermistor and separate headers for connection to an external LCD module and a keypad. Also provided on the PICDEM 3 demonstration board is a LCD panel, with 4 commons and 12 segments, that is capable of displaying time, temperature and day of the week. The PICDEM 3 demonstration board provides an additional RS-232 interface and Windows software for showing the demultiplexed LCD signals on a PC. A simple serial interface allows the user to construct a hardware demultiplexer for the LCD signals.

19.14 PICDEM 17 Demonstration Board

The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. All necessary hardware is included to run basic demo programs, which are supplied on a 3.5-inch disk. A programmed sample is included and the user may erase it and program it with the other sample programs using the PRO MATE II device programmer, or the PICSTART Plus development programmer, and easily debug and test the sample code. In addition, the PICDEM 17 demonstration board supports downloading of programs to and executing out of external FLASH memory on board. The PICDEM 17 demonstration board is also usable with the MPLAB ICE in-circuit emulator, or the PICMASTER emulator and all of the sample programs can be run and modified using either emulator. Additionally, a generous prototype area is available for user hardware.

19.15 KEELOQ Evaluation and Programming Tools

KEELOQ evaluation and programming tools support Microchip's HCS Secure Data Products. The HCS evaluation kit includes a LCD display to show changing codes, a decoder to decode transmissions and a programming interface to program test transmitters.

FIGURE 20-3: PIC17LC7XX-08 VOLTAGE-FREQUENCY GRAPH

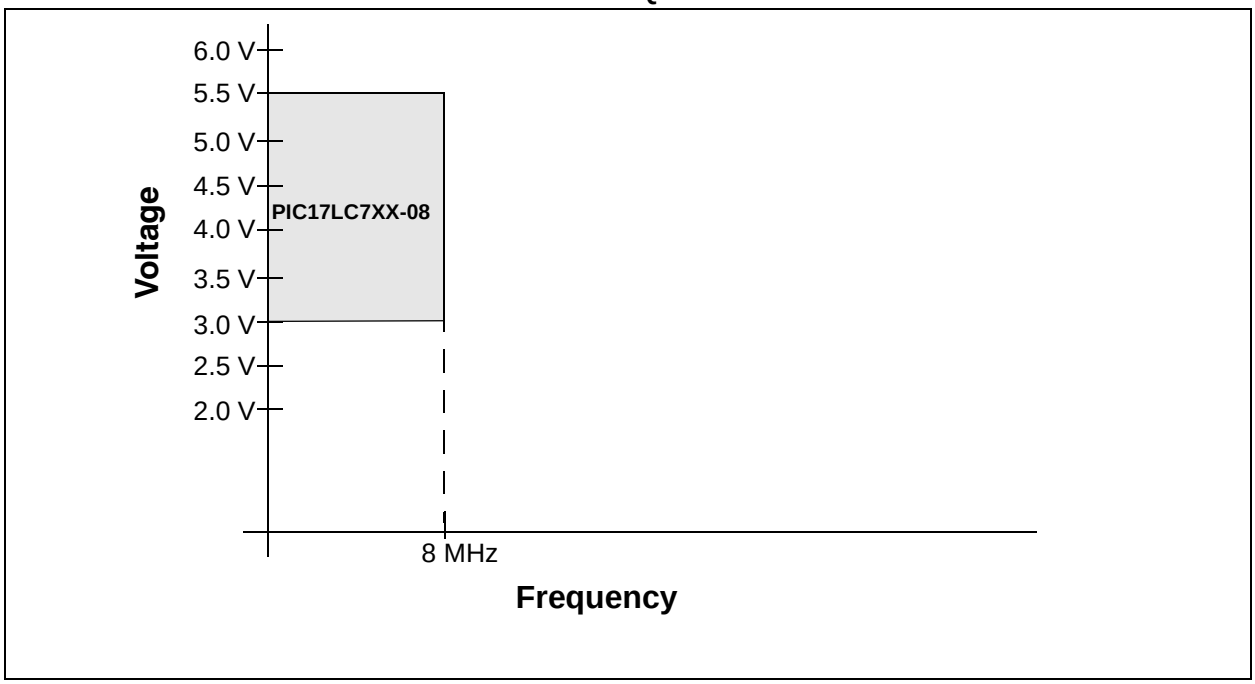
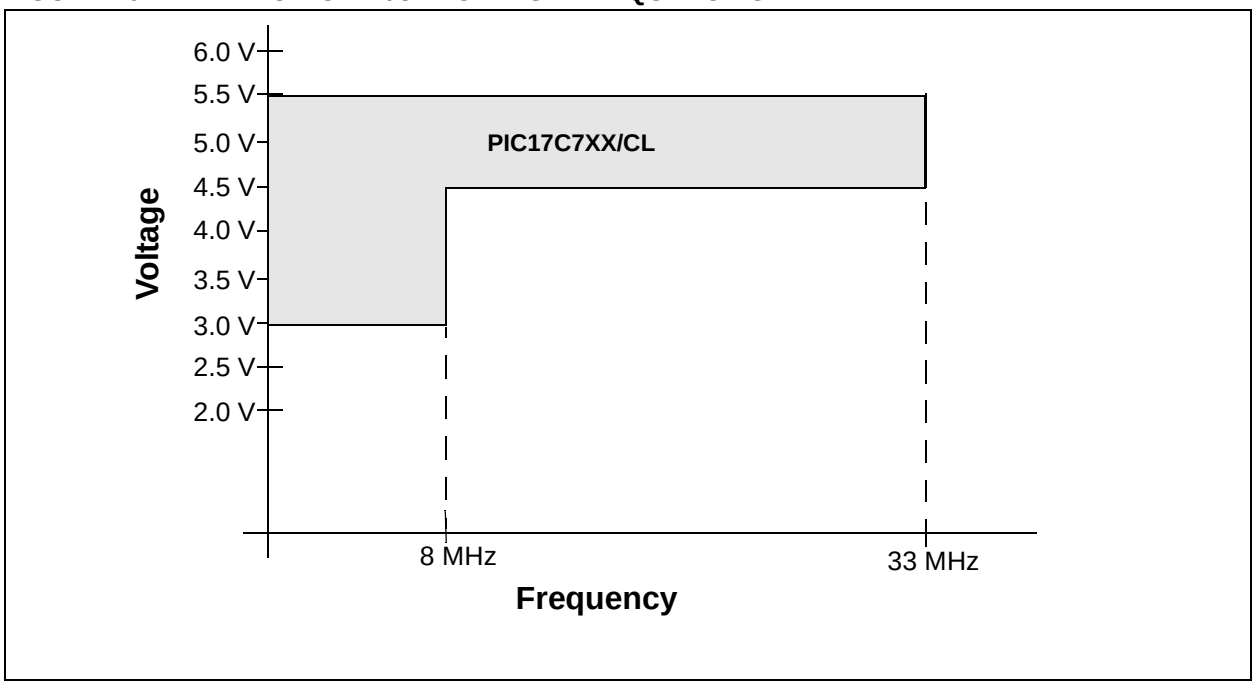


FIGURE 20-4: PIC17C7XX/CL VOLTAGE-FREQUENCY GRAPH



DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C for extended -40°C ≤ TA ≤ +85°C for industrial 0°C ≤ TA ≤ +70°C for commercial Operating voltage VDD range as described in Section 20.1				
Param. No.	**Sym**	**Characteristic**	**Min**	**Typ†**	**Max**	**Units**	**Conditions**
D150	VOD	**Open Drain High Voltage**	–	–	8.5	V	RA2 and RA3 pins only pulled up to externally applied voltage
		Capacitive Loading Specs on Output Pins					
D100	COSC2	OSC2/CLKOUT pin	–	–	25	pF	In EC or RC osc modes, when OSC2 pin is outputting CLKOUT. External clock is used to drive OSC1.
D101	CIO	All I/O pins and OSC2 (in RC mode)	–	–	50	pF	
D102	CAD	System Interface Bus (PORTC, PORTD and PORTE)	–	–	50	pF	In Microprocessor or Extended Microcontroller mode
		Internal Program Memory Programming Specs (Note 4)					
D110	VPP	Voltage on MCLR/VPP pin	12.75	–	13.25	V	**(Note 5)**
D111	VDDP	Supply voltage during programming	4.75	5.0	5.25	V	
D112	IPP	Current into MCLR/VPP pin	–	25	50	mA	
D113	IDDP	Supply current during programming	–	–	30	mA	
D114	TPROG	Programming pulse width	100	–	1000	ms	Terminated via internal/ external interrupt or a RESET

† Data in "Typ" column is at 5V, 25°C unless otherwise stated.

Note 1: In RC oscillator configuration, the OSC1/CLKIN pin is a Schmitt Trigger input. It is not recommended that the PIC17CXXX devices be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on the applied voltage level. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as current sourced by the pin.

4: These specifications are for the programming of the on-chip program memory EPROM through the use of the table write instructions. The complete programming specifications can be found in: PIC17C7XX Programming Specifications (Literature number DS TBD).

5: The MCLR/VPP pin may be kept in this range at times other than programming, but is not recommended.

6: For TTL buffers, the better of the two specifications may be used.

Note 1: When using the Table Write for internal programming, the device temperature must be less than 40°C.

2: For In-Circuit Serial Programming (ICSP™), refer to the device programming specification.

FIGURE 20-13: SPI MASTER MODE TIMING (CKE = 0)

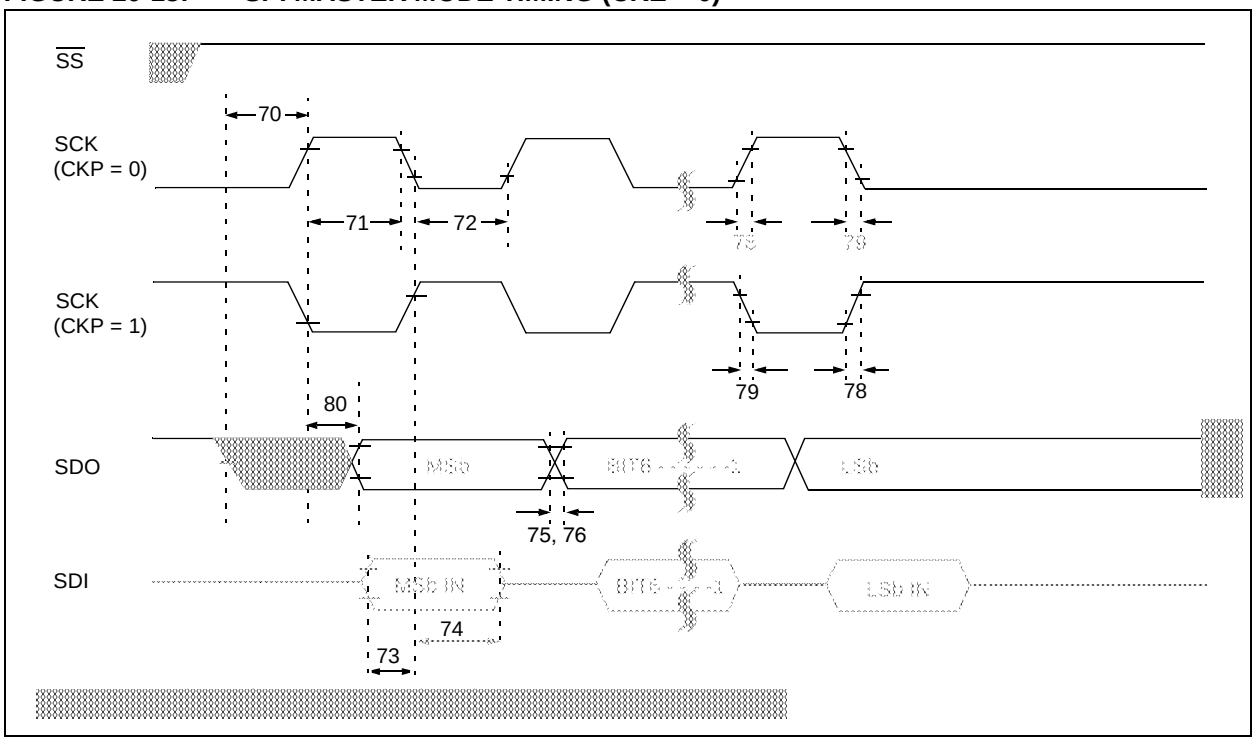


TABLE 20-8: SPI MODE REQUIREMENTS (MASTER MODE, CKE = 0)

Param. No.	Symbol	Characteristic		Min	Typ†	Max	Units	Conditions
70	TssL2scH, TssL2scL	$\overline{SS}\downarrow$ to SCK$\downarrow$ or SCK$\uparrow$ input		Tcy	—	—	ns	
71	TscH	SCK input high time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
71A			Single Byte	40	—	—	ns	**(Note 1)**
72	TscL	SCK input low time (Slave mode)	Continuous	1.25TCY + 30	—	—	ns	
72A			Single Byte	40	—	—	ns	**(Note 1)**
73	TdiV2scH, TdiV2scL	Setup time of SDI data input to SCK edge		100	—	—	ns	
73A	TB2B	Last clock edge of Byte1 to the 1st clock edge of Byte2		1.5TCY + 40	—	—	ns	**(Note 1)**
74	TscH2diL, TscL2diL	Hold time of SDI data input to SCK edge		100	—	—	ns	
75	TdoR	SDO data output rise time		—	10	25	ns	
76	TdoF	SDO data output fall time		—	10	25	ns	
78	TscR	SCK output rise time (Master mode)		—	10	25	ns	
79	TscF	SCK output fall time (Master mode)		—	10	25	ns	
80	TscH2doV, TscL2doV	SDO data output valid after SCK edge		—	—	50	ns	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated.

Note 1: Specification 73A is only required if specifications 71A and 72A are used.

FIGURE 20-25: MEMORY INTERFACE READ TIMING

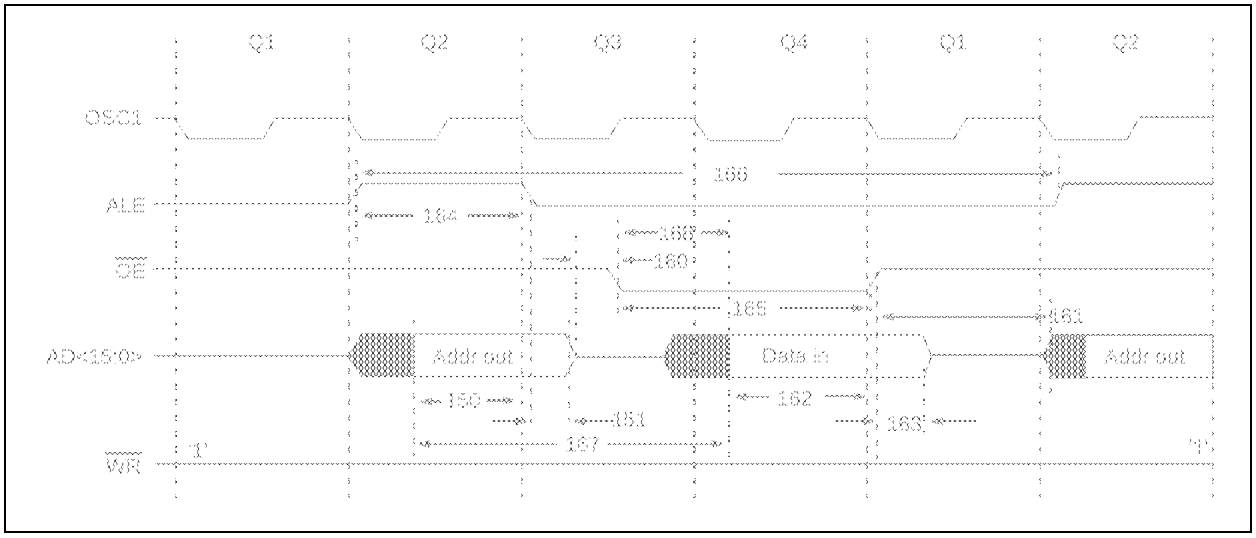


TABLE 20-21: MEMORY INTERFACE READ REQUIREMENTS

Param. No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
150	TadV2alL	AD15:AD0 (address) valid to ALE↓ (address setup time)	PIC17**C**XXX	0.25TCY - 10	—	—	ns	
			PIC17**LC**XXX	0.25TCY - 10	—	—		
151	TalL2adI	ALE↓ to address out invalid (address hold time)	PIC17**C**XXX	5	—	—	ns	
			PIC17**LC**XXX	5	—	—		
160	TadZ2oeL	AD15:AD0 hi-impedance to $\overline{OE}$↓	PIC17**C**XXX	0	—	—	ns	
			PIC17**LC**XXX	0	—	—		
161	ToeH2adD	$\overline{OE}$↑ to AD15:AD0 driven	PIC17**C**XXX	0.25TCY - 15	—	—	ns	
			PIC17**LC**XXX	0.25TCY - 15	—	—		
162	TadV2oeH	Data in valid before $\overline{OE}$↑ (data setup time)	PIC17**C**XXX	35	—	—	ns	
			PIC17**LC**XXX	45	—	—		
163	ToeH2adI	$\overline{OE}$↑to data in invalid (data hold time)	PIC17**C**XXX	0	—	—	ns	
			PIC17**LC**XXX	0	—	—		
164	TalH	ALE pulse width	PIC17**C**XXX	—	0.25TCY	—	ns	
			PIC17**LC**XXX	—	0.25TCY	—		
165	ToeL	$\overline{OE}$ pulse width	PIC17**C**XXX	0.5TCY - 35	—	—	ns	
			PIC17**LC**XXX	0.5TCY - 35	—	—		
166	TalH2alH	ALE↑ to ALE↑(cycle time)	PIC17**C**XXX	—	TCY	—	ns	
			PIC17**LC**XXX	—	TCY	—		
167	Tacc	Address access time	PIC17**C**XXX	—	—	0.75TCY - 30	ns	
			PIC17**LC**XXX	—	—	0.75TCY - 45		
168	Toe	Output enable access time ($\overline{OE}$ low to data valid)	PIC17**C**XXX	—	—	0.5TCY - 45	ns	
			PIC17**LC**XXX	—	—	0.5TCY - 75		

† Data in "Typ" column is at 5V, 25°C unless otherwise stated.

FIGURE 21-4: TYPICAL RC OSCILLATOR FREQUENCY vs. VDD

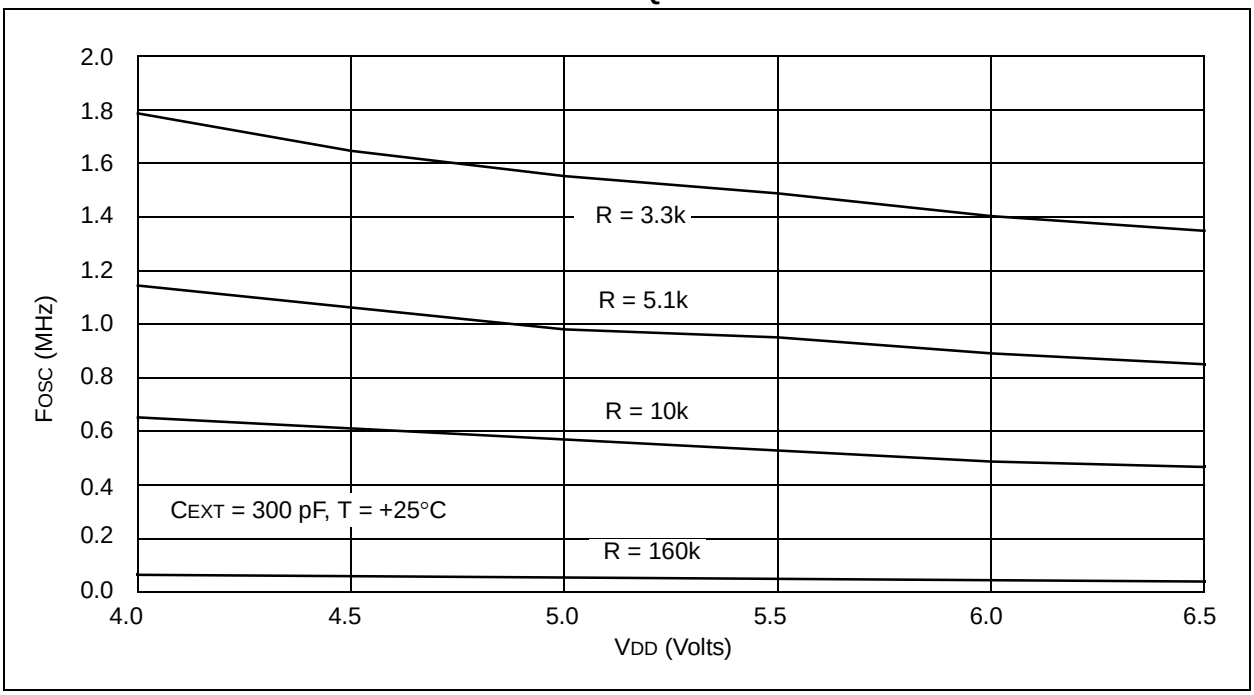


TABLE 21-2: RC OSCILLATOR FREQUENCIES

CEXT	REXT	Average FOSC @ 5V, +25°C	
22 pF	10k	3.33 MHz	± 12%
	100k	353 kHz	± 13%
100 pF	3.3k	3.54 MHz	± 10%
	5.1k	2.43 MHz	± 14%
	10k	1.30 MHz	± 17%
	100k	129 kHz	± 10%
300 pF	3.3k	1.54 MHz	± 14%
	5.1k	980 kHz	± 12%
	10k	564 kHz	± 16%
	160k	35 kHz	± 18%

NOTES: